PMP8380 Rev B - Modifications required for assembly on PMP6547 PCB

- 1) Footprint Changes:
 - a. L3 pad sizes wrong on PCB
 - b. T2 different package and pin out
 - c. C11 different package
 - d. L1 different package
- 2) Added Components:
 - a. R103; current sense resistor
 - b. C102 and R102; primary-side compensation
 - c. D100, R101, and C101; secondary-side snubber
 - d. D101, D102, Q100, and Q101; synchronous gate drive
 - e. C100; output capacitor
 - f. R100; pull-up for TL431

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